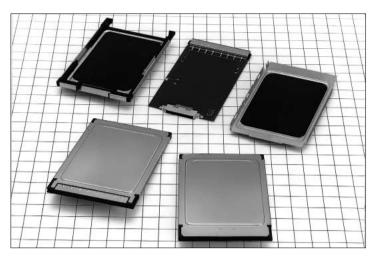
Simple Assembly Type PC Card Frame Kits

NX1 Series



■Features

1. Great reduction of the number of frame kit assembly steps

Use of this simple assembly method has greatly reduced the number of assembly steps. Processes such heat fusion and cooling of the covers are no longer required. Assembly of the frame kit is possible using simple iig tools. (See the Simple Assembly Method insert to the right.).

2. Excellent Shielding Qualities

The covered construction using a metal panel out to the sides of the card provide excellent shielding qualities. (See Figure 4.)

3. Board Offset

Available in types with board offsets of 0.3mm and 0.9mm.

4. Back connectors

Back Connectors available with 15,25, and 32 contacts.

5. Can Be Used With CardBus Types

6. Stable Conduction Maintained Between Panels

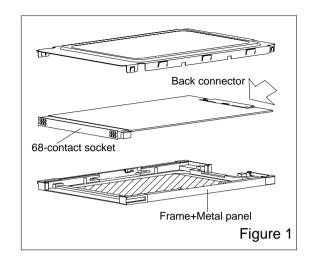
The spring quality of the metal ensures stable conduction to be maintained between the panels at the panel lock portion.

7. Conduction Maintained Between Panel and Board

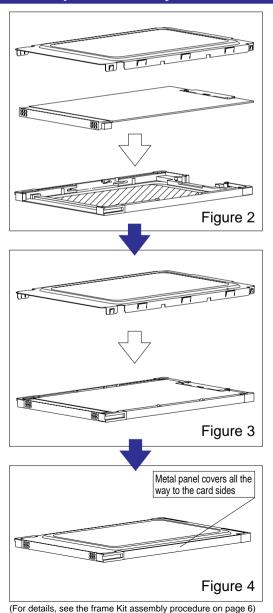
The cunduction between panel and board is maintained by contact between the panel and a one-body ground spring.

Applications

A wide variety of PC cards including LAN, FAX modem, and SCSI.



Simple Assembly Method



■Product Rating

Operating temperature range	-30°C to +70°C
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■Materials

Part	Material	Color	Remarks
Frame	PBT	Black	UL94V-0
Panel Stainless steel		Dull Finish	
Insulation tape	Polyester	Black	510-FR

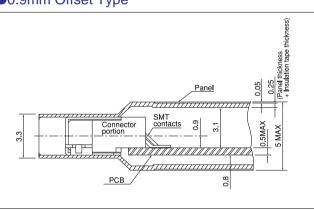
■Ordering Information

NX1B L - 32 T - KT 3 B (05)

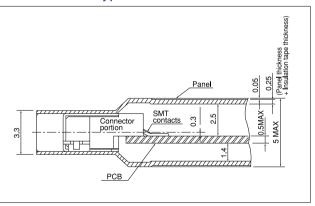
① Series name NX1 : General type NX1B: Card bus type	Suitable back connectors T: NX Series Sonnector type	 Type of suitable 68-contact connectorsK: General type (IC1K Series)B: Card Bus type (IC9 Series)
② Card key type None: 5 V type L: 3.3 V type ③ Number of back connector 15, 25, or 32	KT: Frame kit ® Offset 3: 0.3mm 9: 0.9mm	Presence of insulation tape 05: With insulation tape 06: Without insulation tape

■Connector Mounting Condition (Back conector side)

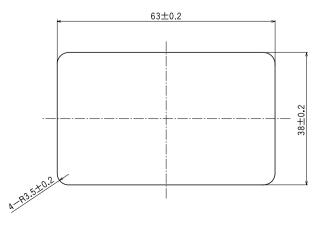
●0.9mm Offset Type



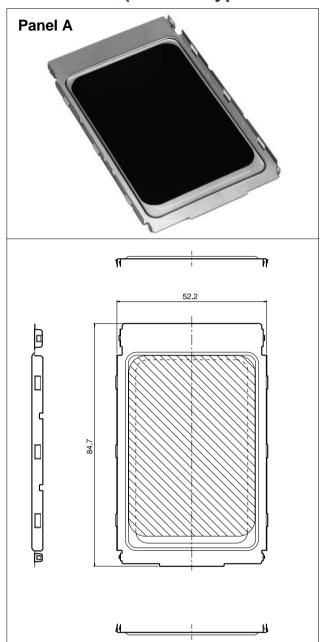
●0.3mm Offset Type

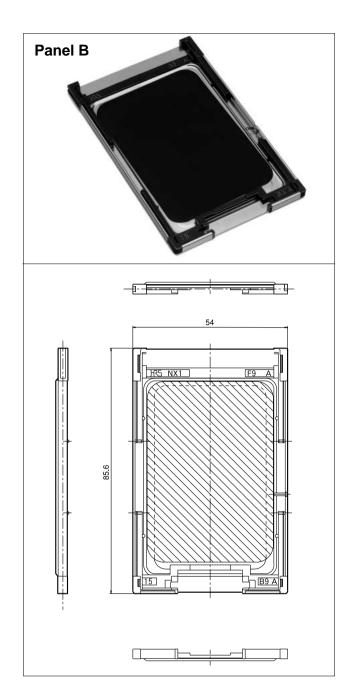


■ Label Dimensions (Recommended Label Thickness: 50µm)



■NX1 Series (General Type Frame Kit)

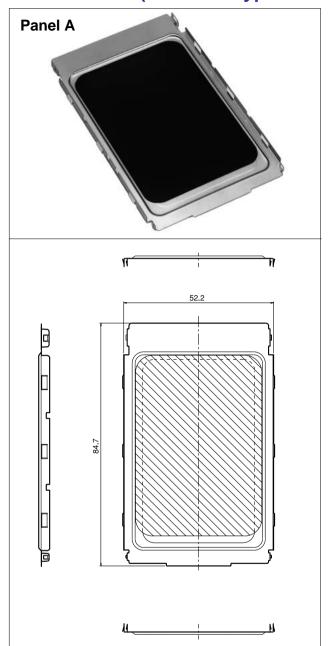


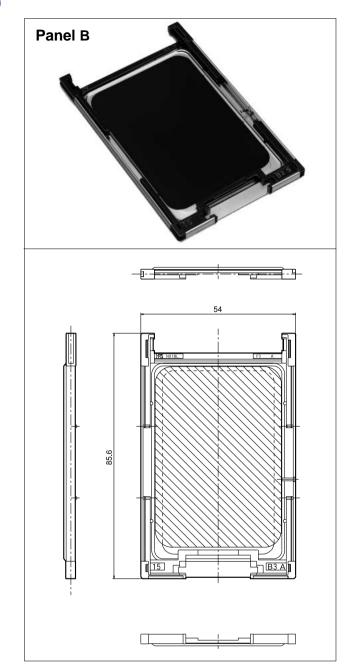


Number of	Offset	Frame Kit		Suitable 68-Contact Socket Connectors		Suitable Back Connectors		
Contacts	(mm)	Part Number	CL No.	Part Number	CL No.	Part Number	CL No.	
15	0.9	NX1-15T-KT9K(**)	234-2102-5-**	IC1K-68RD-1.27SFA	640-0047-2	NX60TB-15SAA9-SP	234-0097-6	
15 0.3	NX1-15T-KT3K(**)	234-2103-8-**	IC1K-68RD-1.27SF	640-0046-0	NX60TB-15SAA3-SP	234-0098-9		
25	0.9	NX1-25T-KT9K(**)	234-2104-0-**	IC1K-68RD-1.27SFA	640-0047-2	NX60TA-25SAA9-SP	234-0107-8	
25	0.3	NX1-25T-KT3K(**)	234-2105-3-**	IC1K-68RD-1.27SF	640-0046-0	NX60TA-25SAA3-SP	234-0033-3	
32	0.9	NX1-32T-KT9K(**)	234-2106-6-**	IC1K-68RD-1.27SFA	640-0047-2	NX60T -32SAA9-SP	234-0023-0	
32	0.3	NX1-32T-KT3K(**)	234-2107-9-**	IC1K-68RD-1.27SF	640-0046-0	NX60TA-32SAA3-SP	234-0053-0	

(**): (05): With Insulation type (06): Without Insulation type

■NX1B Series (Card Bus Type Frame Kit)





Number of	Offset	Frame Kit		Suitable 68-Contact Socket Connectors		Suitable Back Connectors		
Contacts	(mm)	Part Number	CL No.	Part Number	CL No.	Part Number	CL No.	
15	0.9	NX1BL-15T-KT9B(**)	234-2153-6-**	IC9-68RD-0.635SFA	640-0902-5	NX60TB-15SAA9-SP	234-0097-6	
15	0.3	NX1BL-15T-KT3B(**)	234-2154-9-**	IC9-68RD-0.635SF	640-0901-2	NX60TB-15SAA3-SP	234-0098-9	
25	0.9	NX1BL-25T-KT9B(**)	234-2157-7-**	IC9-68RD-0.635SFA	640-0902-5	NX60TA-25SAA9-SP	234-0107-8	
25	0.3	NX1BL-25T-KT3B(**)		IC9-68RD-0.635SF	640-0901-2	NX60TA-25SAA3-SP	234-0033-3	
32	0.9	NX1BL-32T-KT9B(**)	234-2155-1-**	IC9-68RD-0.635SFA	640-0902-5	NX60T -32SAA9-SP	234-0023-0	
32	0.3	NX1BL-32T-KT3B(**)	234-2156-4-**	IC9-68RD-0.635SF	640-0901-2	NX60TA-32SAA3-SP	234-0053-0	

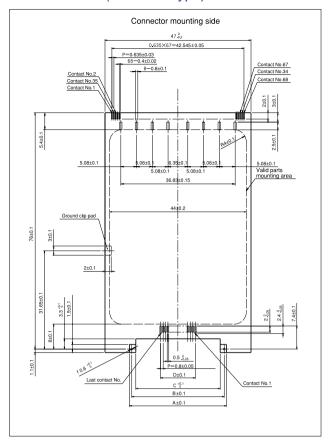
(**): (05): With Insulation type (06): Without Insulation type

●Board Dimensions (Applicable Board Thickness: 0.5 mm Max.)

●NX1 Series (General Type)

Connector mounting side 47.0.2 1>45 +0.1 0.635×67=42 545±0 05 P=0.635±0.03 Contact No.67 Contact No.34 68-0.4±0.02 Contact No.68 4.6±0.1 Valied parts mounting area Ground clip pad 2±0.1 3.3 % 1.5±0.1 P=0.8±0.05 D±0.1 Last contact N Contact No.1 B±0.1 NOTE 1> The dimensions portion of the diagram (i.e., the dotted line portion) is not required when a positioning jig or another aid is used to mount the connectors.

●NX1B Series (CardBus Type)



Туре	Part Number	Number of Contacts	Offset	А	В	С	D
	NX1-15T-KT9K(**)	15		31.2	29.8	27.2	11.2
	NX1-25T-KT9K(**)	25	0.9	39.2	37.8	35.2	19.2
NX 1Series	NX1-32T-KT9K(**)	32		44.8	43.4	40.8	24.8
(General Type)	NX1-15T-KT3K(**)	15		31.2	29.8	27.2	11.2
	NX1-25T-KT3K(**)	25	0.3	39.2	37.8	35.2	19.2
	NX1-32T-KT3K(**)	32		44.8	43.4	40.8	24.8
	NX1BL-15T-KT9B(**)	15		31.2	29.8	27.2	11.2
NX1B Series	NX1BL-25T-KT9B(**)	25	0.9	39.2	37.8	35.2	19.2
(Card Bus Type Frame Kit)	NX1BL-32T-KT9B(**)	32		44.8	43.4	40.8	24.8
	NX1BL-15T-KT3B(**)	15		31.2	29.8	27.2	11.2
	NX1BL-25T-KT3B(**)	25	0.3	39.2	37.8	35.2	19.2
	NX1BL-32T-KT3B(**)	32		44.8	43.4	40.8	24.8

*Please use "NX Series Flame Kit (Not NX 1) "when print processing the panel.

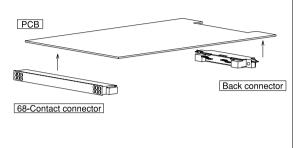
(**): (05): With Insulation type (06): Without Insulation type

● Frame Kit Assembly Process

Assembly Process Figure 1

Mount the connectors(68-contact connectors, back connectors) and other parts to the printed circuit board (PCB).

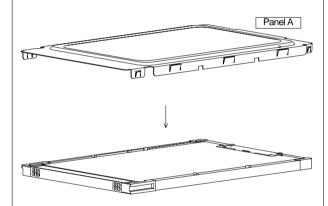
NOTE: The procedure for the IC9 Series (suited to the 68-contact connectors and card bus) is to mount the connector body, then insert the ground plate and fasten the lead portion by hand.



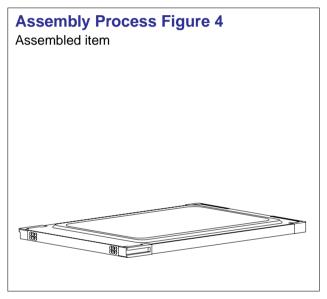
Assembly Process Figure 2 Insert the PCB mounting part to panel B (frame press fitting item). Panel B

Assembly Process Figure 3

Use the assembly jig (described below) to insert panel A. (Press fit + lock)







Assembly Process Figure 5

Affix the label to the indented portion of the panel. NOTE: Hirose Electric Co. Ltd. will not provide label services. (Please refer to the Recommended Label Dimensions Diagram of Page 2.)

